

RF AMPLIFIER

MODEL *TM3003*

Available as: TM3003, 4 Pin TO-8 (T4)
 TN3003, 4 Pin Surface Mount (SM3)
 FP3003, 4 Pin Flatpack (FP4)
 BX3003, Connectorized Housing (H1)

Features

- Output Power: +19.5 dBm Typical
- Medium Gain: 17.5 dB Typical
- Operating Temp.: - 55 °C to + 85 °C
- Environmental Screening Available

Specifications

CHARACTERISTIC	TYPICAL Ta= 25 °C	MIN/MAX Ta = -55 °C to +85 °C
Frequency	800-1200 MHz	800-1200 MHz
Gain (dB)	17.5	15 Min.
Power @ 1 dB Comp. (dBm)	+19.5	+19 Min.
Reverse Isolation (dB)	-28	-26 Max.
VSWR In	<1.75:1	2.0:1 Max.
Out	<1.75:1	2.0:1 Max.
Noise Figure (dB)	5.5	7.0 Max.
Power Vdc	+15	+15
mA	115	125 Max.

Note: Care should always be taken to effectively ground the case of each unit.

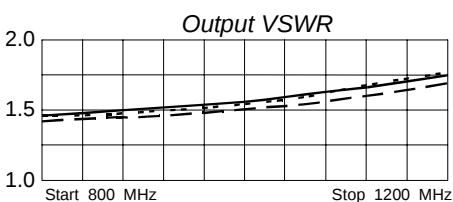
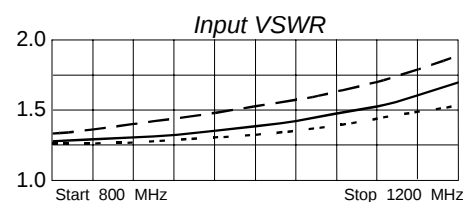
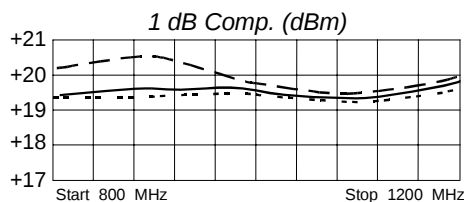
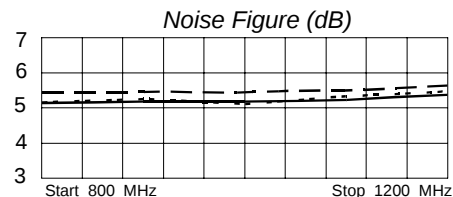
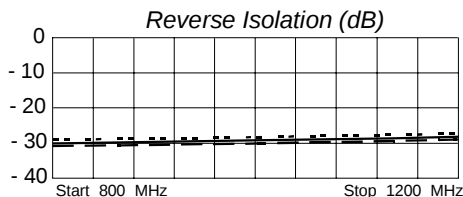
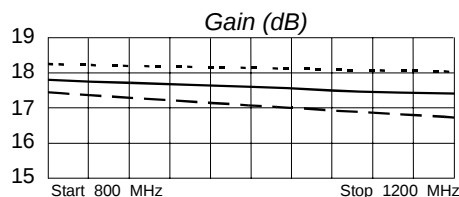
Typical Intermodulation Performance at 25 °C

Second Order Harmonic Intercept Point +46 dBm (Typ.)
 Second Order Two Tone Intercept Point +41 dBm (Typ.)
 Third Order Two Tone Intercept Point +30 dBm (Typ.)

Maximum Ratings

Ambient Operating Temperature -55°C to + 100 °C
 Storage Temperature -62°C to + 125 °C
 Case Temperature + 125 °C
 DC Voltage + 18 Volts
 Continuous RF Input Power + 13 dBm
 Short Term RF Input Power 50 Milliwatts (1 Minute Max.)
 Maximum Peak Power 0.5 Watt (3 µsec Max.)

Typical Performance Data



Legend ——— + 25 °C - - - - + 85 °C -55 °C

